

Plastic NPN Silicon High-Voltage Power Transistor

... designed for use in line-operated equipment such as audio output amplifiers; low-current, high-voltage converters; and AC line relays.

• Excellent DC Current Gain -

 $h_{FE} = 30-250$ @ $I_{C} = 100$ mAdc

• Current-Gain - Bandwidth Product -

 $f_T = 10 \text{ MHz (Min)} @ I_C = 50 \text{ mAdc}$

MAXIMUM RATINGS (1)

Rating	Symbol	2N5655	2N5657	Unit
Collector–Emitter Voltage	VCEO	250 350		Vdc
Collector–Base Voltage	VCB	275	375	Vdc
Emitter-Base Voltage	V _{EB}	6.0		Vdc
Collector Current – Continuous Peak	IC	0.5 1.0		Adc
Base Current	ΙΒ	0.25		Adc
Total Power Dissipation @ T _C = 25°C Derate above 25°C	PD	20 0.16		Watts W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	θJC	6.25	°C/W

(1) Indicates JEDEC Registered Data.

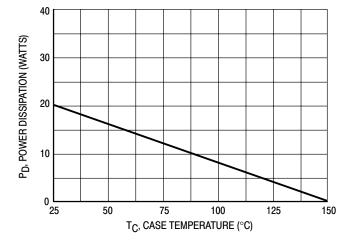
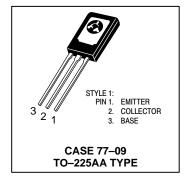


Figure 1. Power Derating

2N5655 2N5657

0.5 AMPERE
POWER TRANSISTORS
NPN SILICON
250-350 VOLTS
20 WATTS



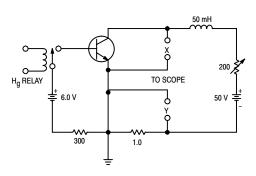


Figure 2. Sustaining Voltage Test Circuit

Safe Area Limits are indicated by Figures 3 and 4. Both limits are applicable and must be observed.

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*ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit	
OFF CHARACTERISTICS						
Collector–Emitter Sustaining Voltage (IC = 100 mAdc (inductive), L = 50 mH)	2N5655 2N5657	VCEO(sus)	250 350	_ _	Vdc	
Collector–Emitter Breakdown Voltage (IC = 1.0 mAdc, IB = 0)	2N5655 2N5657	V _(BR) CEO	250 350	_ _	Vdc	
Collector Cutoff Current ($V_{CE} = 150 \text{ Vdc}, I_B = 0$) ($V_{CE} = 250 \text{ Vdc}, I_B = 0$)	2N5655 2N5657	ICEO		0.1 0.1	mAdc	
Collector Cutoff Current (VCE = 250 Vdc, VEB(off) = 1.5 Vdc) (VCE = 350 Vdc, VEB(off) = 1.5 Vdc) (VCE = 150 Vdc, VEB(off) = 1.5 Vdc, T _C = 100°C) (VCE = 250 Vdc, VEB(off) = 1.5 Vdc, T _C = 100°C)	2N5655 2N5657 2N5655 2N5657	ICEX	- - - -	0.1 0.1 1.0 1.0	mAdc	
Collector Cutoff Current (V _{CB} = 275 Vdc, I _E = 0) (V _{CB} = 375 Vdc, I _E = 0)	2N5655 2N5657	ICBO	-	10 10	μAdc	
Emitter Cutoff Current (V _{EB} = 6.0 Vdc, I _C = 0)		IEBO	_	10	μAdc	
ON CHARACTERISTICS		T		T	1	
DC Current Gain (1) (IC = 50 mAdc, V _{CE} = 10 Vdc) (IC = 100 mAdc, V _{CE} = 10 Vdc) (IC = 250 mAdc, V _{CE} = 10 Vdc) (IC = 500 mAdc, V _{CE} = 10 Vdc)		hFE	25 30 15 5.0	_ 250 _ _	_	

Base–Emitter Voltage (1)	$(I_C = 100 \text{ mAdc}, V_{CE} = 10 \text{ Vdc})$				
DYNAMIC CHARACTERISTICS					

Collector-Emitter Saturation Voltage (1)

 $(I_C = 100 \text{ mAdc}, I_B = 10 \text{ mAdc})$

 $(I_C = 250 \text{ mAdc}, I_B = 25 \text{ mAdc})$

 $(I_C = 500 \text{ mAdc}, I_B = 100 \text{ mAdc})$

Current–Gain – Bandwidth Product (2) (I _C = 50 mAdc, V _{CE} = 10 Vdc, f = 10 MHz)	fT	10	1	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 100 kHz)	C _{ob}	_	25	pF
Small–Signal Current Gain (I _C = 100 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz)	h _{fe}	20	ı	-

^{*}Indicates JEDEC Registered Data for 2N5655 Series.

⁽²⁾ f_T is defined as the frequency at which |h_{fe}| extrapolates to unity.

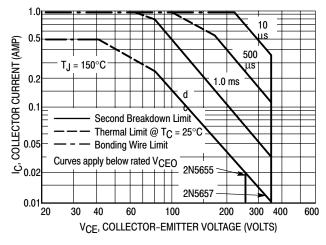


Figure 3. Active-Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_{\hbox{\scriptsize C}}-V_{\hbox{\scriptsize CE}}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

VCE(sat)

 V_{BE}

Vdc

Vdc

1.0

2.5

10

1.0

The data of Figure 3 is based on $TJ_{(pk)} = 150$ °C; T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $TJ_{(pk)} \le 150$ °C. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

⁽¹⁾ Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

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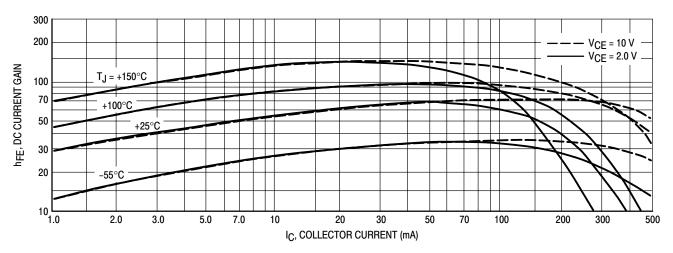


Figure 4. Current Gain

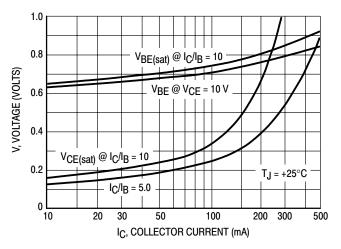


Figure 5. "On" Voltages

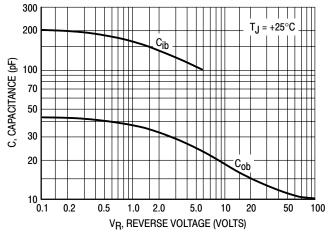


Figure 6. Capacitance

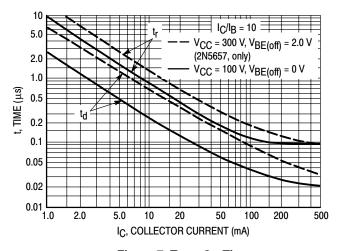


Figure 7. Turn-On Time

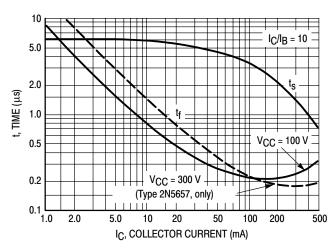
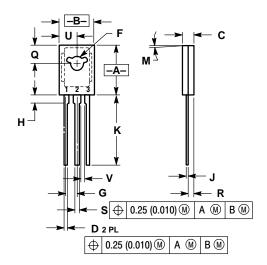


Figure 8. Turn-Off Time

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PACKAGE DIMENSIONS

TO-225AA CASE 77-09 ISSUE W



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
 Y14 5M 1982
- 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.425	0.435	10.80	11.04
В	0.295	0.305	7.50	7.74
С	0.095	0.105	2.42	2.66
D	0.020	0.026	0.51	0.66
F	0.115	0.130	2.93	3.30
G	0.094 BSC		2.39 BSC	
Н	0.050	0.095	1.27	2.41
J	0.015	0.025	0.39	0.63
K	0.575	0.655	14.61	16.63
M	5°	TYP	5° TYP	
Q	0.148	0.158	3.76	4.01
R	0.045	0.065	1.15	1.65
S	0.025	0.035	0.64	0.88
U	0.145	0.155	3.69	3.93
٧	0.040		1.02	

STYLE 1

PIN 1. EMITTER

2. COLLECTOR

3. BASE

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